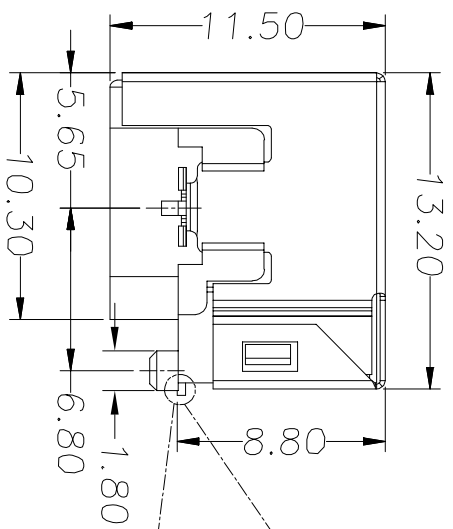
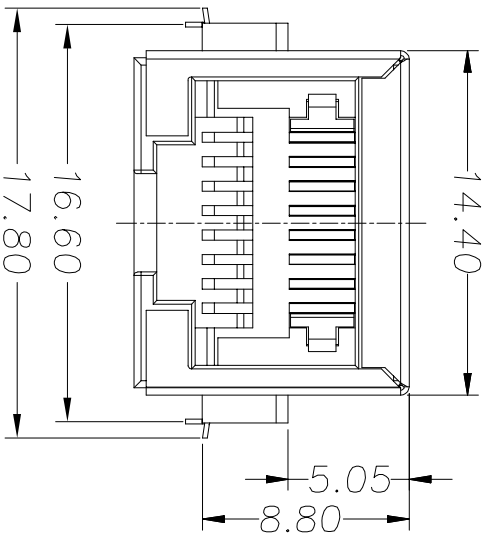
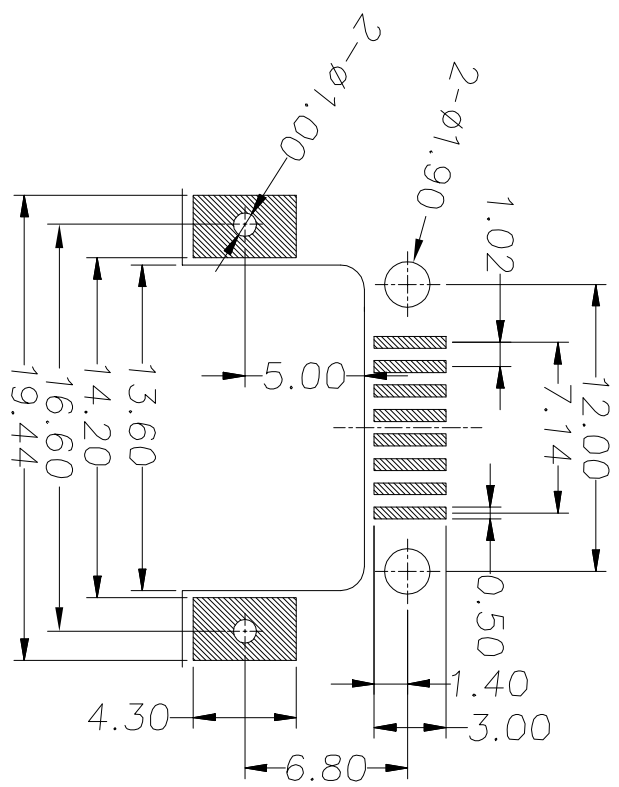
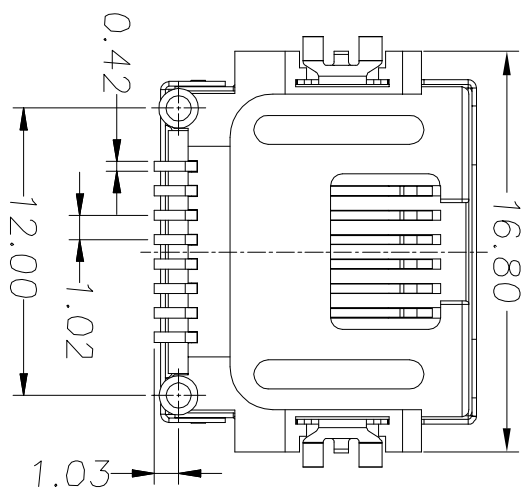
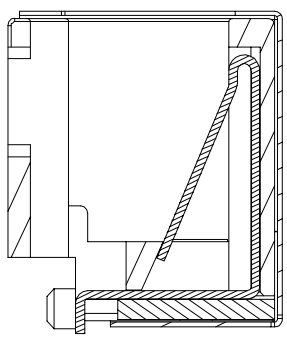


0.05^{+0.10}_{-0.05}



NOTES:

- MATERIAL:
- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER(U94V-0).
 - 2.CONTACT MATERIAL :PHOSPHOR BRONZE T=0.35mm (C5100).
 - 3.PLATING :GOLD PLATING OVER NICKEL.
 - 4.SHIELD: COPPER ALLOY 0.20mm THICKNESS PLATING NI.
- ELECTRICAL:
- 1.VOLTAGE RATING :125 VAC RMS.
 - 2.CURRENT RATING :1.5 AMP.
 - 3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
 - 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
 - 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.
- MECHANICAL:
- 1.DURABILITY :750 CYCLES MIN.
 - 2.PCB RETENTION PRE-SOLDER :1 LB MIN.
- ENVIRONMENTAL:
- 1.STORAGE : -40°C TO +85°C.
 - 2. OPERATION : 0°C TO 70°C.
- MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68,SUBPART F.

PC Board Layout

APPROVALS		DATE	TITLE:		RJ CONNECTOR	
DRAWN	ZHWEI.CHEN	2015.07.07	GEPU歌普		PART NO.	RJ45-9M11-CSN-AB-88-B1
CHECKED					UNIT: mm	SCALE: 1:1
APPROVALS					PROJ.	
TOLERANCES ARE			30~0.15	±0.30	ANGLE	
			10~0.30	±0.20		
			5~0.10	±0.15		
			~ 5	±0.10	±2°	
					DRAWING NO.	
					SHEET	1 OF 1
ECN NO.	REV.	DATE.	NEW		DESCRIPTION.	
	A					